



# **PBA Design-for-Manufacturing Guideline**

EDM-D-000 Good Design-for-X Practice

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EDM-D-000: Good Design-for-X Practice

### The Design-for-eXcellence Guidelines principles

The PBA Design-for-eXcellence (DfX) Guidelines are designed to provide all electronic supply chain actors involved in the design, qualification, industrialization and production of Printed Board Assemblies practical guidelines to master the multi-disciplinary hardware aspects of electronic module realization and operation in a cost-effective way. The PBA DfX Guidelines are not electrical design guidelines. The PBA DfX guidelines provide the electrical designer the boundary conditions of industrial electronic manufacturing technology and operational reliability. It is intended to support the development of cost-effective, reliable PBA with a short time-to-market requiring a minimum number of design iterations.

Some of the characteristics of the PBA DfX Guidelines are:

- The PBA DfX Guidelines are oriented towards the overall optimization of the physical design of the final PBA based product.
- The guidelines refer to the relevant industry standards that are predominantly used in the international electronics industry such as those published by organizations as IPC and JEDEC. The guidelines do not replace industrial standards but define or recommend what options in the standards to use and will fill-in gaps if necessary. They provide the basis on which a company/product/product-line or application specific approach for design, industrialization and/or realization can be defined.
- Scientific argumentation and physical models form the basis of a large part of the guidelines and of the associated tools. This allows the use of the guidelines beyond the boundary of the users' experience domain. Therefore, it provides a powerful product and process innovation aid.
- The PBA DfX Guidelines will not specify, recommend or exclude specific brands of materials, components, suppliers or products. They will put forward minimal requirements on quality, physical and chemical properties and testing. They define and provide the DfManufacturing window for PBA realization.
- The PBA DfX Guidelines are based on verifiable physical models, standards and empirical data.

## PBA DfX Guideline Scope

- The PBA DfX guidelines cover lead-free SnAgCu and SnPb solder based assembly.
- The PBA DfX guidelines include: Design-for-Manufacturing, Design-for-Assembly, Design-for-Test, Design-for-Reliability, Design-for-RoHS, etc.



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### **Contributing cEDM partners**

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# EDM-D-000: Good Design-for-X Practice

# **Table of Contents**

The Design-for-eXcellence Guidelines principles	
PBA DfX Guideline Scope	
Acknowledgement	
1. Applicable Documents	<u>E</u>
2. Applicability of the PBA DfX Guideline EDM-D-000	
3. To acknowledge when designing PBA	
4. Do's and don'ts of good DfX practice	
5. Basic PCB Design-for-Manufacturing rules	
6. Basic Design-for-Assembly rules	
7. Basic Design-for-Test rules	
8. Basic Design-for-Reliability rules	11
8.1. General	
8.2. PBA subjected to strong thermal cycling	11
8.3. Mechanically stressed PBA: bending, vibration and shock	11
8.4. Insulation reliability	12
8.5. BOM (component) reliability	12
Appendix 1: cEDM Guideline overview	
DfX Guidelines	
Qualification guidelines	15
Manufacturing guidelines	
Revisions	



EDM-D-000: Good Design-for-X Practice

# 1. Applicable Documents

This PBA DfX Guideline refers as part of the guideline to the most recent versions of the following documents and standards including their amendments.

IPC-CM-770E Guidelines for Printed Board Component Mounting

## 2. Applicability of the PBA DfX Guideline EDM-D-000

- The recommendations given in the guideline are intended to help the user in making choices that improve the manufacturability, reliability, testability, etc., of the final PBA. These recommendations are of a generic nature. Therefore, in specific cases more optimal solutions may exist.
- Design specification takes precedence over this guideline.
- IPC class 2 requirements and test procedures apply unless specified otherwise in this document.
- EDM-D-000 provides a concise overview of the basics of a good PBA Design-for-Manufacturing practice and some basic elements of Design-for-Reliability. The details required for application and implementation can be found in the set of EDM DfX guidelines.